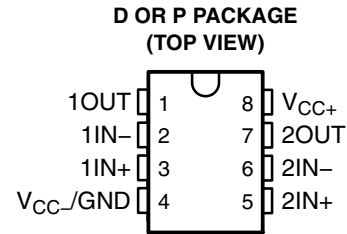


# TL3472

## HIGH-SLEW-RATE, SINGLE-SUPPLY OPERATIONAL AMPLIFIER

SLOS200G – OCTOBER 1997 – REVISED JULY 2003

- **Wide Gain-Bandwidth Product . . . 4 MHz**
- **High Slew Rate . . . 13 V/ $\mu$ s**
- **Fast Settling Time . . . 1.1  $\mu$ s to 0.1%**
- **Wide-Range Single-Supply Operation . . . 4 V to 36 V**
- **Wide Input Common-Mode Range Includes Ground ( $V_{CC-}$ )**
- **Low Total Harmonic Distortion . . . 0.02%**
- **Large-Capacitance Drive Capability . . . 10,000 pF**
- **Output Short-Circuit Protection**



### description/ordering information

Quality, low-cost, bipolar fabrication with innovative design concepts is employed for the TL3472 operational amplifier. This device offers 4 MHz of gain-bandwidth product, 13-V/ $\mu$ s slew rate, and fast settling time, without the use of JFET device technology. Although the TL3472 can be operated from split supplies, it is particularly suited for single-supply operation because the common-mode input voltage range includes ground potential ( $V_{CC-}$ ). With a Darlington transistor input stage, this device exhibits high input resistance, low input offset voltage, and high gain. The all-npn output stage, characterized by no dead-band crossover distortion and large output voltage swing, provides high-capacitance drive capability, excellent phase and gain margins, low open-loop high-frequency output impedance, and symmetrical source/sink ac frequency response. This low-cost amplifier is an alternative to the MC33072 and the MC34072 operational amplifiers.

### ORDERING INFORMATION

| $T_A$          | PACKAGE† |              | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|----------------|----------|--------------|-----------------------|------------------|
| 0°C to 70°C    | PDIP (P) | Tube of 25   | TL3472CP              | TL3472CP         |
|                | SOIC (D) | Tube of 50   | TL3472CD              | 3472C            |
|                |          | Reel of 2500 | TL3472CDR             |                  |
| -40°C to 105°C | PDIP (P) | Tube of 25   | TL3472IP              | TL3472IP         |
|                | SOIC (D) | Tube of 50   | TL3472ID              | Z3472            |
|                |          | Reel of 2500 | TL3472IDR             |                  |

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at [www.ti.com/sc/package](http://www.ti.com/sc/package).



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**TEXAS  
INSTRUMENTS**

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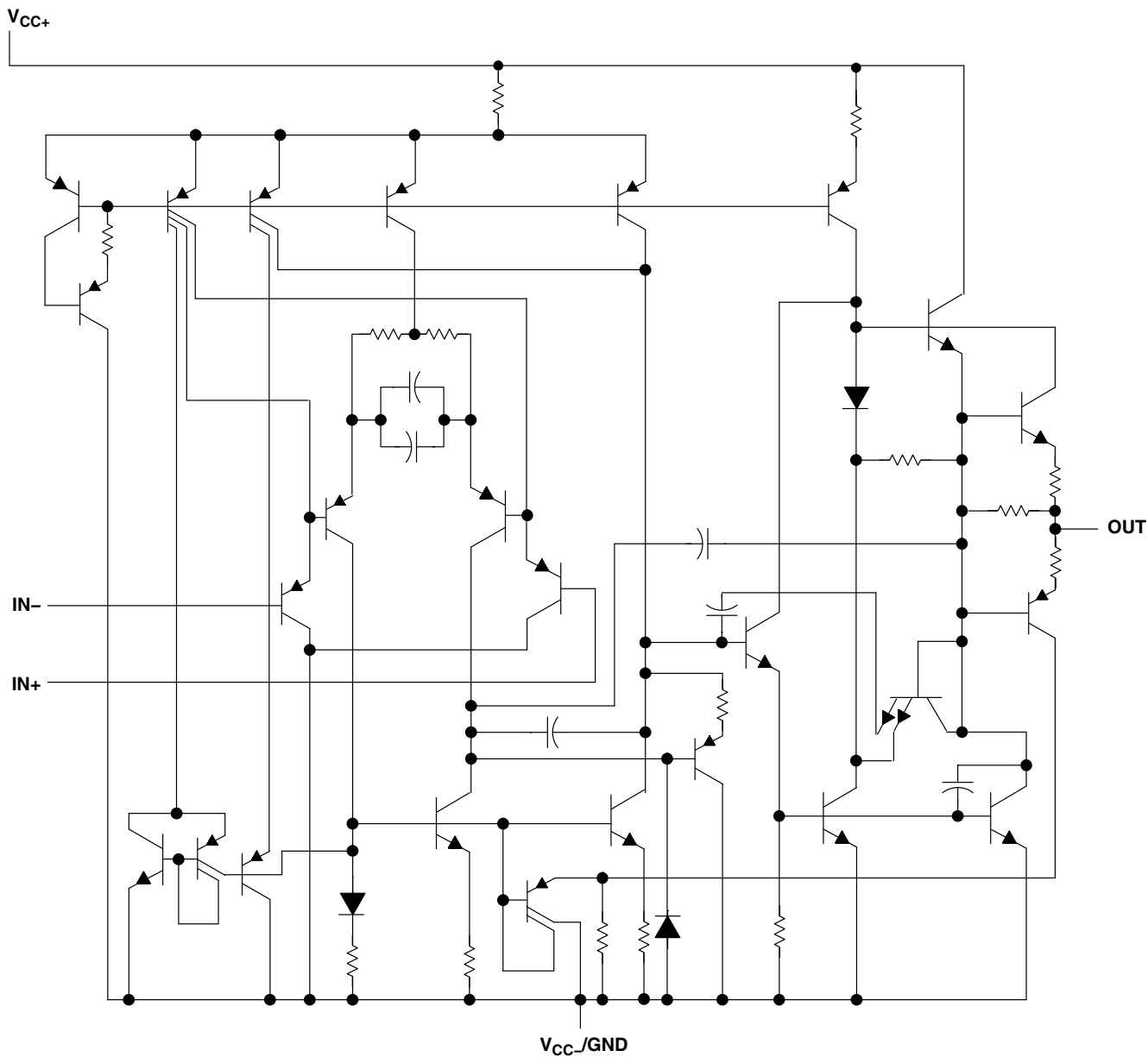
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# TL3472

## HIGH-SLEW-RATE, SINGLE-SUPPLY OPERATIONAL AMPLIFIER

SLOS200G – OCTOBER 1997 – REVISED JULY 2003

### schematic (each amplifier)



# TL3472

## HIGH-SLEW-RATE, SINGLE-SUPPLY OPERATIONAL AMPLIFIER

SLOS200G – OCTOBER 1997 – REVISED JULY 2003

### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

|                                                                         |                |
|-------------------------------------------------------------------------|----------------|
| Supply voltage (see Note 1): $V_{CC+}$                                  | 18 V           |
| $V_{CC-}$                                                               | –18 V          |
| Differential input voltage, $V_{ID}$ (see Note 2)                       | $\pm 36$ V     |
| Input voltage, $V_I$ (any input)                                        | $V_{CC\pm}$    |
| Input current, $I_I$ (each input)                                       | $\pm 1$ mA     |
| Output current, $I_O$                                                   | $\pm 80$ mA    |
| Total current into $V_{CC+}$                                            | 80 mA          |
| Total current out of $V_{CC-}$                                          | 80 mA          |
| Duration of short-circuit current at (or below) 25°C (see Note 3)       | Unlimited      |
| Package thermal impedance, $\theta_{JA}$ (see Notes 4 and 5): D package | 97°C/W         |
| P package                                                               | 85°C/W         |
| Operating virtual junction temperature, $T_J$                           | 150°C          |
| Lead temperature 1.6 mm (1/16 inch) from case for 10 seconds            | 260°C          |
| Storage temperature range, $T_{stg}$                                    | –65°C to 150°C |

<sup>†</sup> Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES:
1. All voltage values, except differential voltages, are with respect to the midpoint between  $V_{CC+}$  and  $V_{CC-}$ .
  2. Differential voltages are at the noninverting input with respect to the inverting input. Excessive input current can flow when the input is less than  $V_{CC-} - 0.3$  V.
  3. The output can be shorted to either supply. Temperature and/or supply voltages must be limited to ensure that the maximum dissipation rating is not exceeded.
  4. Maximum power dissipation is a function of  $T_J(\text{max})$ ,  $\theta_{JA}$ , and  $T_A$ . The maximum allowable power dissipation at any allowable ambient temperature is  $P_D = (T_J(\text{max}) - T_A)/\theta_{JA}$ . Operating at the absolute maximum  $T_J$  of 150°C can impact reliability.
  5. The package thermal impedance is calculated in accordance with JESD 51-7.

### recommended operating conditions

|             |                                |                        | MIN | MAX  | UNIT |
|-------------|--------------------------------|------------------------|-----|------|------|
| $V_{CC\pm}$ | Supply voltage                 |                        | 4   | 36   | V    |
| $V_{IC}$    | Common-mode input voltage      | $V_{CC} = 5$ V         | 0   | 2.8  | V    |
|             |                                | $V_{CC\pm} = \pm 15$ V | –15 | 12.8 |      |
| $T_A$       | Operating free-air temperature | TL3472C                | 0   | 70   | °C   |
|             |                                | TL3472I                | –40 | 105  |      |



# TL3472

## HIGH-SLEW-RATE, SINGLE-SUPPLY OPERATIONAL AMPLIFIER

SLOS200G – OCTOBER 1997 – REVISED JULY 2003

electrical characteristics at specified free-air temperature,  $V_{CC\pm} = \pm 15\text{ V}$  (unless otherwise noted)

| PARAMETER        |                                                                       | TEST CONDITIONS                                                               |                                                 | T <sub>A</sub>          | MIN         | TYP†  | MAX  | UNIT |
|------------------|-----------------------------------------------------------------------|-------------------------------------------------------------------------------|-------------------------------------------------|-------------------------|-------------|-------|------|------|
| V <sub>IO</sub>  | Input offset voltage                                                  | V <sub>IC</sub> = 0,<br>V <sub>O</sub> = 0,<br>R <sub>S</sub> = 50 Ω          | V <sub>CC</sub> = 5 V                           | 25°C                    | 1.5         |       | 10   | mV   |
|                  |                                                                       |                                                                               | V <sub>CC</sub> = ±15 V                         | 25°C                    | 1.0         |       | 10   |      |
| Full range‡      | 12                                                                    |                                                                               |                                                 |                         |             |       |      |      |
|                  | α <sub>V<sub>IO</sub></sub>                                           |                                                                               | Temperature coefficient of input offset voltage | V <sub>CC</sub> = ±15 V | Full range‡ | 10    |      |      |
| I <sub>IO</sub>  | Input offset current                                                  |                                                                               | V <sub>CC</sub> = ±15 V                         | 25°C                    | 6           |       | 75   | nA   |
|                  |                                                                       |                                                                               |                                                 | Full range‡             | 300         |       |      |      |
| I <sub>IB</sub>  | Input bias current                                                    |                                                                               | V <sub>CC</sub> = ±15 V                         | 25°C                    | 100         |       | 500  | nA   |
|                  |                                                                       |                                                                               |                                                 | Full range‡             | 700         |       |      |      |
| V <sub>ICR</sub> | Common-mode input voltage range                                       | R <sub>S</sub> = 50 Ω                                                         | 25°C                                            | –15<br>to<br>12.8       |             | V     |      |      |
|                  |                                                                       |                                                                               | Full range‡                                     | –15<br>to<br>12.8       |             |       |      |      |
| V <sub>OH</sub>  | High-level output voltage                                             | V <sub>CC+</sub> = 5 V, V <sub>CC–</sub> = 0, R <sub>L</sub> = 2 kΩ           | 25°C                                            | 3.7                     |             | 4     | V    |      |
|                  |                                                                       | R <sub>L</sub> = 10 kΩ                                                        | 25°C                                            | 13.6                    |             | 14    |      |      |
|                  |                                                                       | R <sub>L</sub> = 2 kΩ                                                         | Full range‡                                     | 13.4                    |             |       |      |      |
| V <sub>OL</sub>  | Low-level output voltage                                              | V <sub>CC+</sub> = 5 V, V <sub>CC–</sub> = 0, R <sub>L</sub> = 2 kΩ           | 25°C                                            | 0.1                     |             | 0.3   | V    |      |
|                  |                                                                       | R <sub>L</sub> = 10 kΩ                                                        | 25°C                                            | –14.7                   |             | –14.3 |      |      |
|                  |                                                                       | R <sub>L</sub> = 2 kΩ                                                         | Full range‡                                     | –13.5                   |             |       |      |      |
| A <sub>VD</sub>  | Large-signal differential voltage amplification                       | V <sub>O</sub> = ±10 V, R <sub>L</sub> = 2 kΩ                                 | 25°C                                            | 25                      |             | 100   | V/mV |      |
|                  |                                                                       |                                                                               | Full range‡                                     | 20                      |             |       |      |      |
| I <sub>OS</sub>  | Short-circuit output current                                          | Source: V <sub>ID</sub> = 1 V, V <sub>O</sub> = 0                             | 25°C                                            | –10                     |             | –34   | mA   |      |
|                  |                                                                       | Sink: V <sub>ID</sub> = –1 V, V <sub>O</sub> = 0                              |                                                 | 20                      |             | 27    |      |      |
| CMRR             | Common-mode rejection ratio                                           | V <sub>IC</sub> = V <sub>ICR</sub> (min), R <sub>S</sub> = 50 Ω               | 25°C                                            | 65                      | 97          |       | dB   |      |
| k <sub>SVR</sub> | Supply-voltage rejection ratio (ΔV <sub>CC±</sub> /ΔV <sub>IO</sub> ) | V <sub>CC±</sub> = ±13.5 V to ±16.5 V, R <sub>S</sub> = 100 Ω                 | 25°C                                            | 70                      | 97          |       | dB   |      |
| I <sub>CC</sub>  | Supply current (per channel)                                          | V <sub>O</sub> = 0, No load                                                   | 25°C                                            | 3.5                     |             | 4.5   | mA   |      |
|                  |                                                                       |                                                                               | Full range‡                                     | 4.5                     |             | 5.5   |      |      |
|                  |                                                                       | V <sub>CC+</sub> = 5 V, V <sub>O</sub> = 2.5 V, V <sub>CC–</sub> = 0, No load | 25°C                                            | 3.5                     |             | 4.5   |      |      |

† All typical values are at  $T_A = 25^\circ\text{C}$ .

‡ Full range is  $0^\circ\text{C}$  to  $70^\circ\text{C}$  for the TL3472C device and  $-40^\circ\text{C}$  to  $105^\circ\text{C}$  for the TL3472I device.

# TL3472

## HIGH-SLEW-RATE, SINGLE-SUPPLY OPERATIONAL AMPLIFIER

SLOS200G – OCTOBER 1997 – REVISED JULY 2003

operating characteristics,  $V_{CC\pm} = \pm 15\text{ V}$ ,  $T_A = 25^\circ\text{C}$

| PARAMETER |                                | TEST CONDITIONS                                                                                           |                       | MIN | TYP  | MAX | UNIT                         |
|-----------|--------------------------------|-----------------------------------------------------------------------------------------------------------|-----------------------|-----|------|-----|------------------------------|
| SR+       | Positive slew rate             | $V_I = -10\text{ V to } 10\text{ V}$ ,<br>$R_L = 2\text{ k}\Omega$ , $C_L = 300\text{ pF}$                | $A_V = 1$             | 8   | 10   |     | $\text{V}/\mu\text{s}$       |
| SR–       | Negative slew rate             |                                                                                                           | $A_V = -1$            |     | 13   |     | $\text{V}/\mu\text{s}$       |
| $t_s$     | Settling time                  | $A_{VD} = -1$ , 10-V step                                                                                 | To 0.1%               |     | 1.1  |     | $\mu\text{s}$                |
|           |                                |                                                                                                           | To 0.01%              |     | 2.2  |     |                              |
| $V_n$     | Equivalent input noise voltage | $f = 1\text{ kHz}$ ,<br>$R_S = 100\ \Omega$                                                               |                       |     | 49   |     | $\text{nV}/\sqrt{\text{Hz}}$ |
| $I_n$     | Equivalent input noise current | $f = 1\text{ kHz}$                                                                                        |                       |     | 0.22 |     | $\text{pA}/\sqrt{\text{Hz}}$ |
| THD       | Total harmonic distortion      | $V_{O(PP)} = 2\text{ V to } 20\text{ V}$ , $R_L = 2\text{ k}\Omega$ , $A_{VD} = 10$ , $f = 10\text{ kHz}$ |                       |     | 0.02 |     | %                            |
| GBW       | Gain-bandwidth product         | $f = 100\text{ kHz}$                                                                                      |                       | 3   | 4    |     | MHz                          |
| BW        | Power bandwidth                | $V_{O(PP)} = 20\text{ V}$ , $R_L = 2\text{ k}\Omega$ , $A_{VD} = 1$ , THD = 5.0%                          |                       |     | 160  |     | kHz                          |
| $\phi_m$  | Phase margin                   | $R_L = 2\text{ k}\Omega$                                                                                  | $C_L = 0$             |     | 70   |     | deg                          |
|           |                                |                                                                                                           | $C_L = 300\text{ pF}$ |     | 50   |     |                              |
|           | Gain margin                    | $R_L = 2\text{ k}\Omega$                                                                                  | $C_L = 0$             |     | 12   |     | dB                           |
|           |                                |                                                                                                           | $C_L = 300\text{ pF}$ |     | 4    |     |                              |
| $r_i$     | Differential input resistance  | $V_{IC} = 0$                                                                                              |                       |     | 150  |     | $\text{M}\Omega$             |
| $C_i$     | Input capacitance              | $V_{IC} = 0$                                                                                              |                       |     | 2.5  |     | pF                           |
|           | Channel separation             | $f = 10\text{ kHz}$                                                                                       |                       |     | 101  |     | dB                           |
| $z_o$     | Open-loop output impedance     | $f = 1\text{ MHz}$ ,<br>$A_V = 1$                                                                         |                       |     | 20   |     | $\Omega$                     |



## PACKAGING INFORMATION

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2)            | Lead/Ball Finish<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|------------------|---------------|--------------|--------------------|------|----------------|----------------------------|-------------------------|----------------------|--------------|-------------------------|-------------------------|
| TL3472CD         | ACTIVE        | SOIC         | D                  | 8    | 75             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | 0 to 70      | 3472C                   | <a href="#">Samples</a> |
| TL3472CDG4       | ACTIVE        | SOIC         | D                  | 8    | 75             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | 0 to 70      | 3472C                   | <a href="#">Samples</a> |
| TL3472CDR        | ACTIVE        | SOIC         | D                  | 8    | 2500           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | 0 to 70      | 3472C                   | <a href="#">Samples</a> |
| TL3472CDRG4      | ACTIVE        | SOIC         | D                  | 8    | 2500           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | 0 to 70      | 3472C                   | <a href="#">Samples</a> |
| TL3472CP         | ACTIVE        | PDIP         | P                  | 8    | 50             | Pb-Free<br>(RoHS)          | CU NIPDAU               | N / A for Pkg Type   | 0 to 70      | TL3472CP                | <a href="#">Samples</a> |
| TL3472ID         | ACTIVE        | SOIC         | D                  | 8    | 75             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 105   | Z3472                   | <a href="#">Samples</a> |
| TL3472IDR        | ACTIVE        | SOIC         | D                  | 8    | 2500           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 105   | Z3472                   | <a href="#">Samples</a> |
| TL3472IP         | ACTIVE        | PDIP         | P                  | 8    | 50             | Pb-Free<br>(RoHS)          | CU NIPDAU               | N / A for Pkg Type   | -40 to 105   | TL3472IP                | <a href="#">Samples</a> |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

<sup>(5)</sup> Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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**OTHER QUALIFIED VERSIONS OF TL3472 :**

- Automotive: [TL3472-Q1](#)

NOTE: Qualified Version Definitions:

- Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects

**TAPE AND REEL INFORMATION**
**REEL DIMENSIONS**

**TAPE DIMENSIONS**

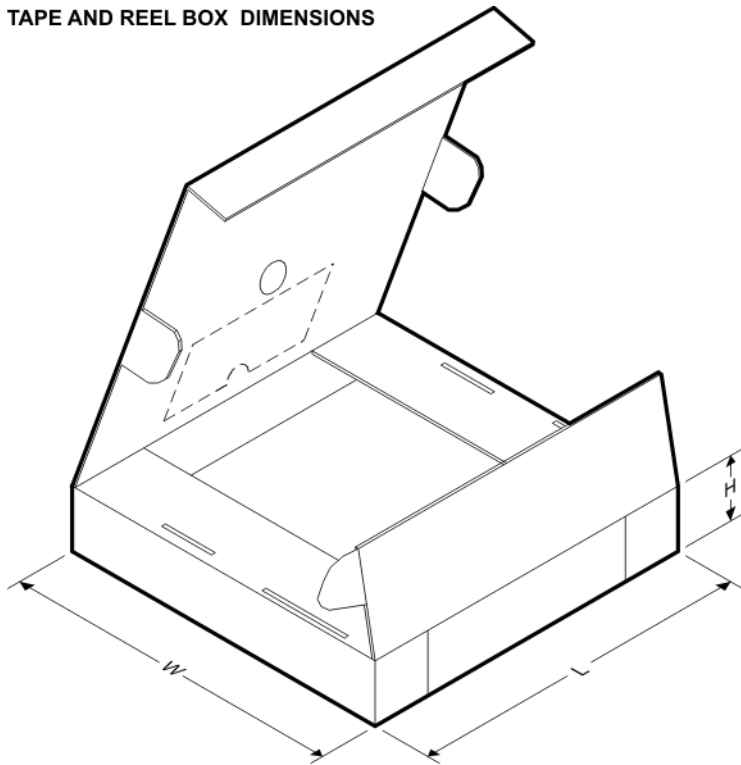

|    |                                                           |
|----|-----------------------------------------------------------|
| A0 | Dimension designed to accommodate the component width     |
| B0 | Dimension designed to accommodate the component length    |
| K0 | Dimension designed to accommodate the component thickness |
| W  | Overall width of the carrier tape                         |
| P1 | Pitch between successive cavity centers                   |

**TAPE AND REEL INFORMATION**

\*All dimensions are nominal

| Device    | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-----------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| TL3472CDR | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| TL3472CDR | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| TL3472IDR | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| TL3472IDR | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |

## TAPE AND REEL BOX DIMENSIONS

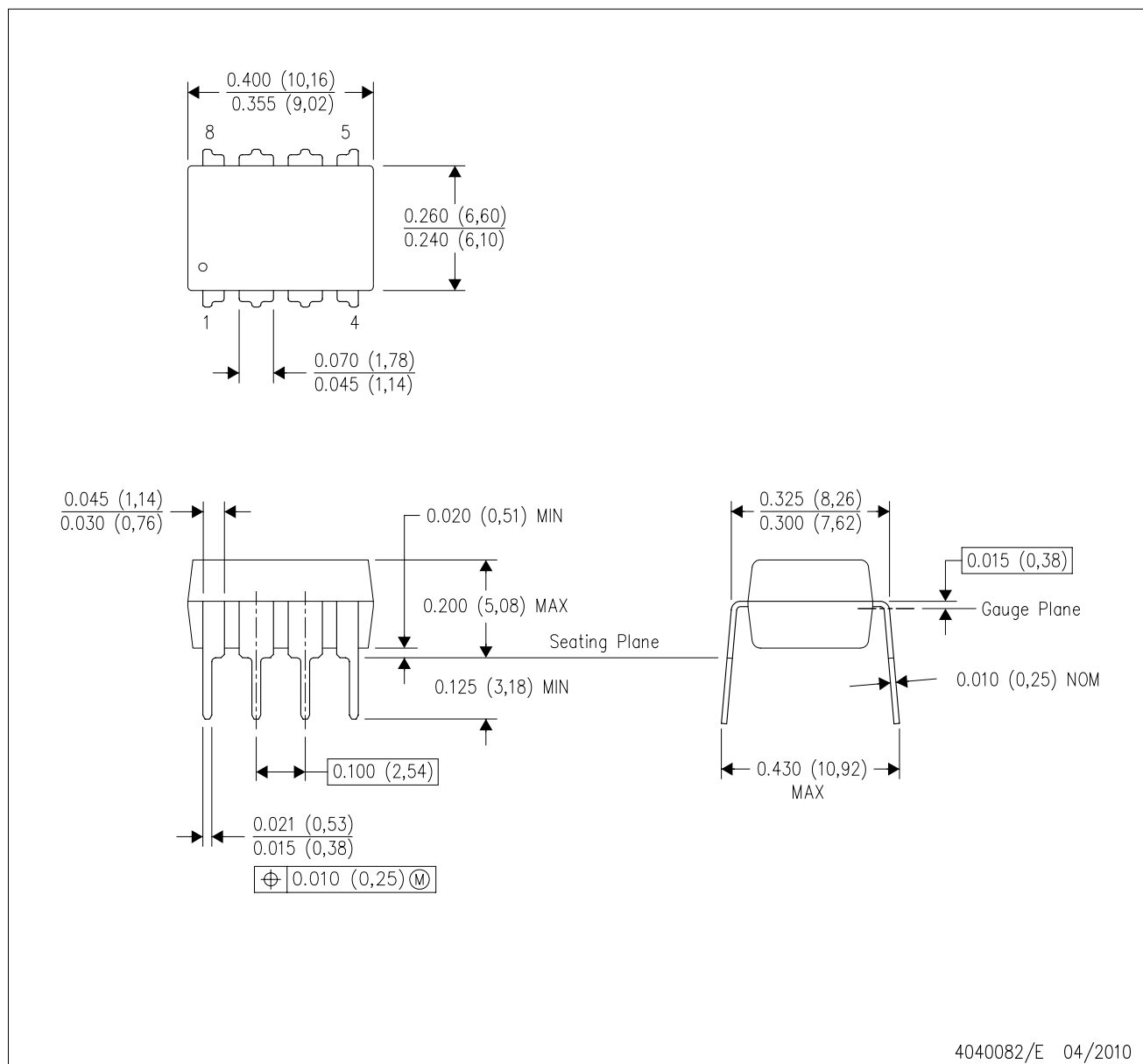


\*All dimensions are nominal

| Device    | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-----------|--------------|-----------------|------|------|-------------|------------|-------------|
| TL3472CDR | SOIC         | D               | 8    | 2500 | 367.0       | 367.0      | 35.0        |
| TL3472CDR | SOIC         | D               | 8    | 2500 | 340.5       | 338.1      | 20.6        |
| TL3472IDR | SOIC         | D               | 8    | 2500 | 340.5       | 338.1      | 20.6        |
| TL3472IDR | SOIC         | D               | 8    | 2500 | 367.0       | 367.0      | 35.0        |

P (R-PDIP-T8)

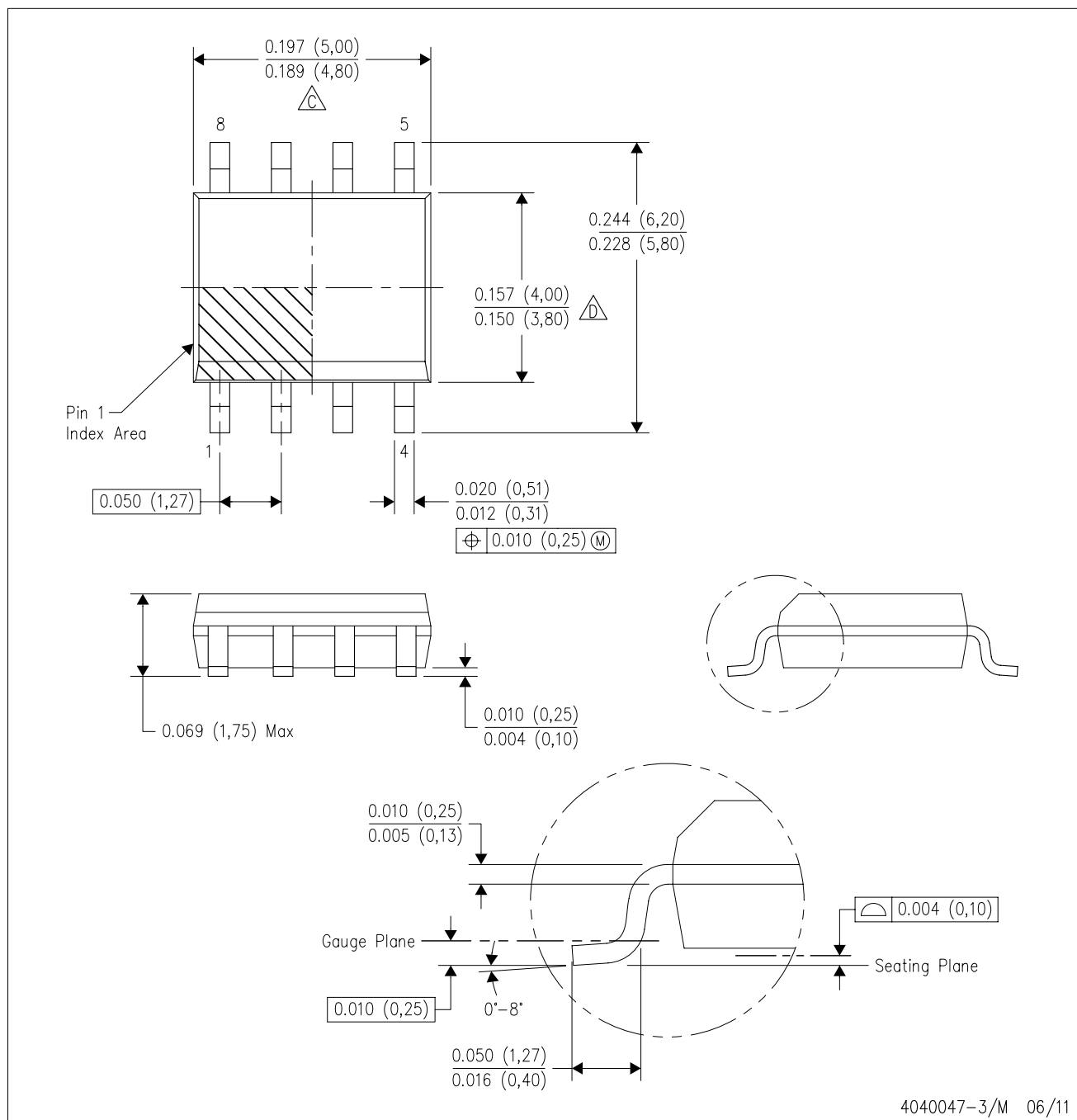
PLASTIC DUAL-IN-LINE PACKAGE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. Falls within JEDEC MS-001 variation BA.

D (R-PDSO-G8)

PLASTIC SMALL OUTLINE

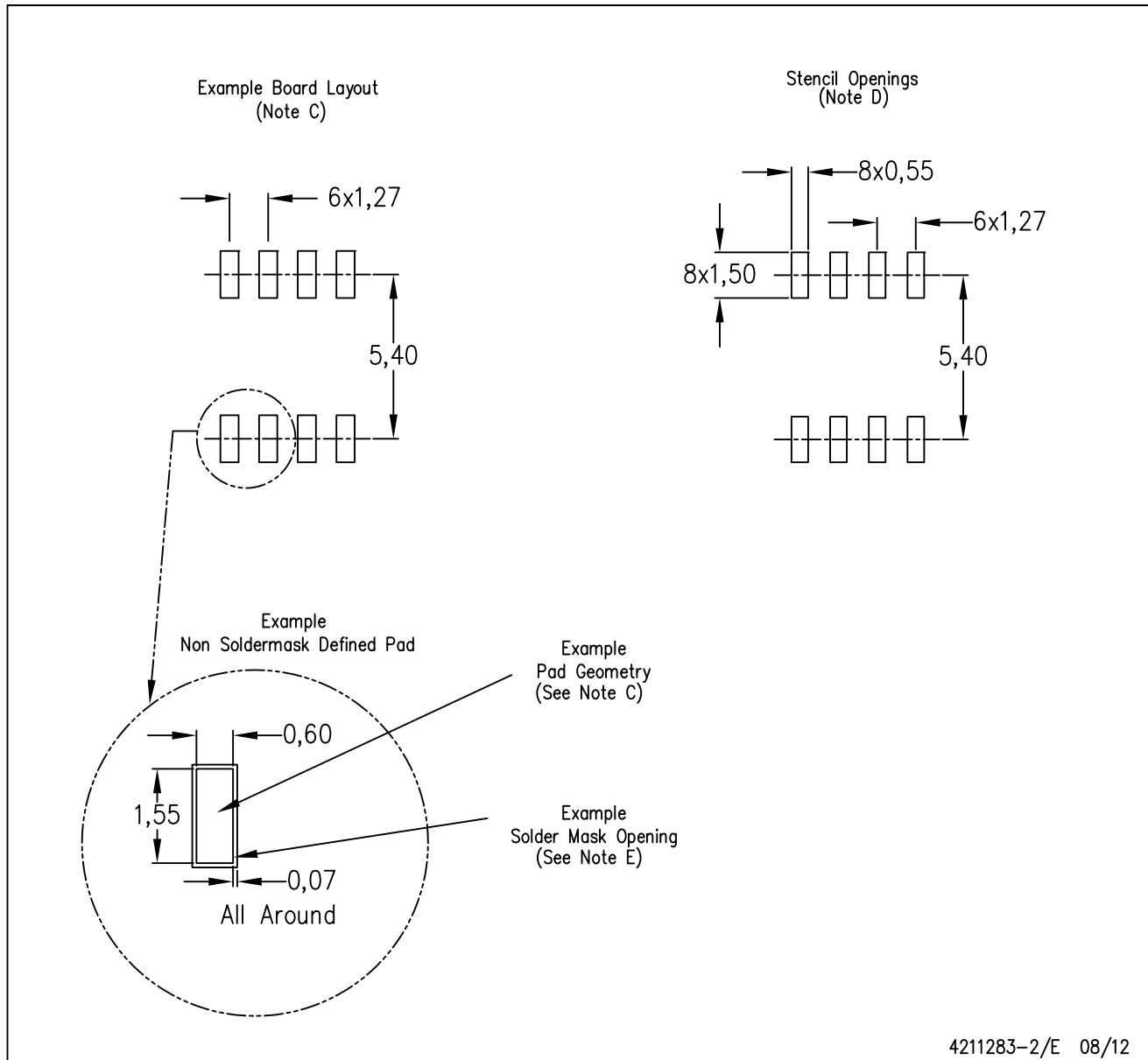


## NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- $\triangle C$  Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- $\triangle D$  Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AA.

D (R-PDSO-G8)

PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Publication IPC-7351 is recommended for alternate designs.
  - D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
  - E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

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|                               |                                                                                          |
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